COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

the specification of which

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

FLIP-CHIP PACKAGE SUBSTRATE

_X	_ is attached hereto. _ was filed on					
	as Application Serial No		and was amended on			
ap ap for	ecification, including t I acknowledge the plication in accordand I hereby claim fore plication(s) for paten	the claims, as amended to duty to disclose information with Title 37, Code of the control of the	nd understand the content d by any amendment referred rmation which is material to of Federal Regulations, § 1. der Title 35, United States Co ate listed below and have ificate having a filing date be	ed to above. the patent 56(a). code, § 119 also identifi	ability of this of any foreign	
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
	92205531	Taiwan, R.O.C.	2003/4/9	X		
tra	= - •		s) and/or agent(s) to prosec nark Office connected therev		lication and to	
	Belinda Lee Jiawei Huang Charles C.H. Wu	(Reg. No. 46,86 (Reg. No. 43,336 (Reg. No. 39,08	0)	(Reg. No	. 53,226)	
	SEND CORRESPOR	NDENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number) Belinda Lee		
		800				

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:

Chi-Hring Han Date: Apr. 28, 2003

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